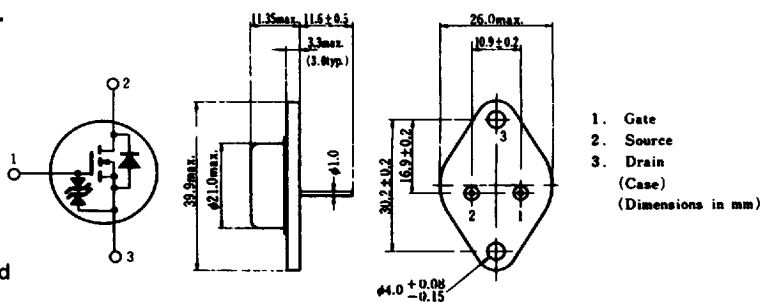


2SK1371, 2SK1372

SILICON N-CHANNEL MOS FET HIGH SPEED POWER SWITCHING

■ FEATURES

- Low On-Resistance
- High Speed Switching
- Low Drive Current
- No Secondary Breakdown
- Suitable for Switching Regulator and DC-DC Converter

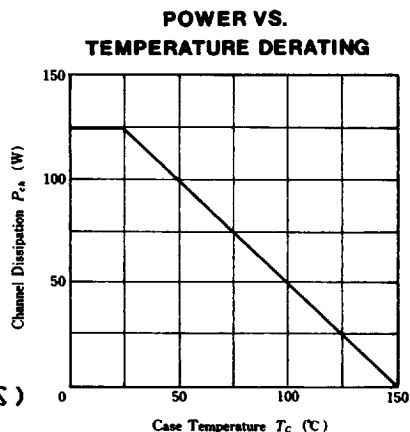


(JEDEC TO-3)

■ ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$)

Item	Symbol	2SK1371	2SK1372	Unit
Drain-Source Voltage	V_{DS}	450	500	V
Gate-Source Voltage	V_{GS}	± 30		V
Drain Current	I_D	20		A
Drain Peak Current	$I_{D(\text{pulse})}$	80		A
Body-Drain Diode Reverse Drain Current	I_{DR}	20		A
Channel Dissipation	P_{ca}^{**}	125		W
Channel Temperature	T_{ca}	150		$^\circ\text{C}$
Storage Temperature	T_{stg}	$-55 \sim +150$		$^\circ\text{C}$

* $PW \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$
 ** Value at $T_c=25^\circ\text{C}$



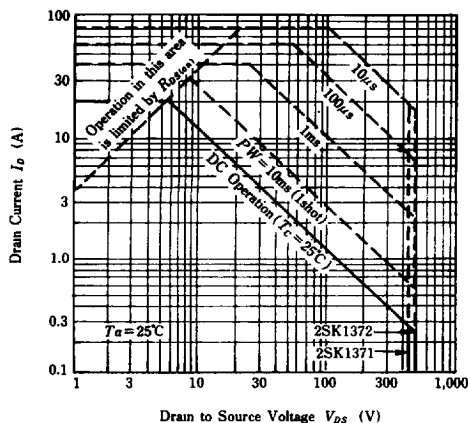
HITACHI/(OPTOELECTRONICS)

■ ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$)

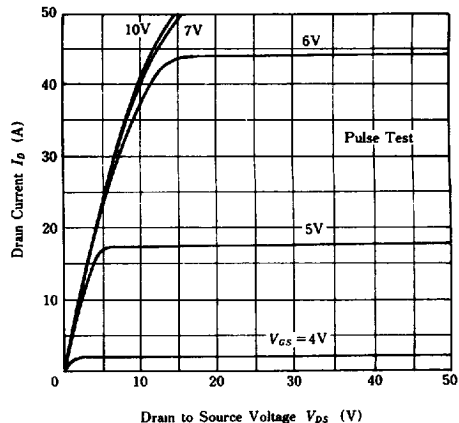
Item	Symbol	Test Condition	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	$V_{(BR)DS}$	$I_D=10\text{mA}$, $V_{GS}=0$	450	—	—	V
			500	—	—	V
Gate-Source Breakdown Voltage	$V_{(BR)GS}$	$I_G=\pm 100 \mu\text{A}$, $V_{DS}=0$	± 30	—	—	V
Gate-Source Leak Current	I_{GSS}	$V_{GS}=\pm 25\text{V}$, $V_{DS}=0$	—	—	± 10	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=360\text{V}$, $V_{GS}=0$	—	—	250	μA
		$V_{DS}=400\text{V}$, $V_{GS}=0$	—	—	—	μA
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$I_D=1\text{mA}$, $V_{DS}=10\text{V}$	2.0	—	3.0	V
Static Drain-Source on State Resistance	$R_{DS(on)}$	$I_D=10\text{A}$, $V_{GS}=10\text{V}^*$	—	0.20	0.25	Ω
			—	0.22	0.27	Ω
Forward Transfer Admittance	$ y_{fs} $	$I_D=10\text{A}$, $V_{DS}=10\text{V}^*$	10	16	—	S
Input Capacitance	C_{iss}	$V_{DS}=10\text{V}$, $V_{GS}=0$, $f=1\text{MHz}$	—	2800	—	pF
Output Capacitance	C_{oss}		—	780	—	pF
Reverse Transfer Capacitance	C_{rss}		—	90	—	pF
Turn-on Delay Time	$t_{d(on)}$	$I_D=10\text{A}$, $V_{GS}=10\text{V}$, $R_L=3\Omega$	—	32	—	ns
Rise Time	t_r		—	115	—	ns
Turn-off Delay Time	$t_{d(off)}$		—	200	—	ns
Fall Time	t_f		—	90	—	ns
Body-Drain Diode Forward Voltage	V_{DF}	$I_F=20\text{A}$, $V_{GS}=0$	—	1.0	—	V
Body-Drain Diode Reverse Recovery Time	t_{rr}	$I_F=20\text{A}$, $V_{GS}=0$, $di_F/dt=100\text{A}/\mu\text{s}$	—	500	—	ns

* Pulse Test

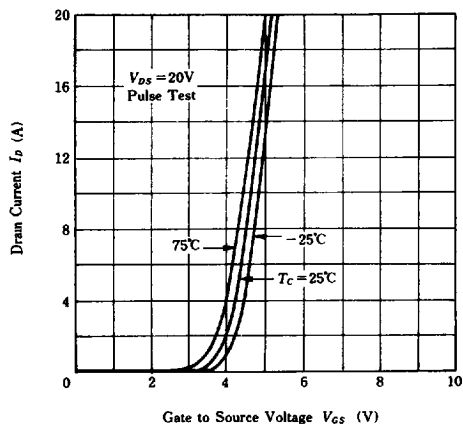
MAXIMUM SAFE OPERATION AREA



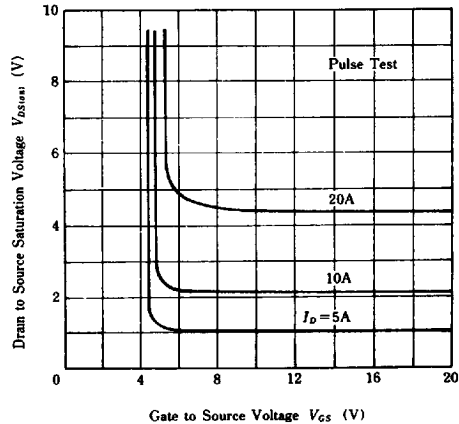
TYPICAL OUTPUT CHARACTERISTICS



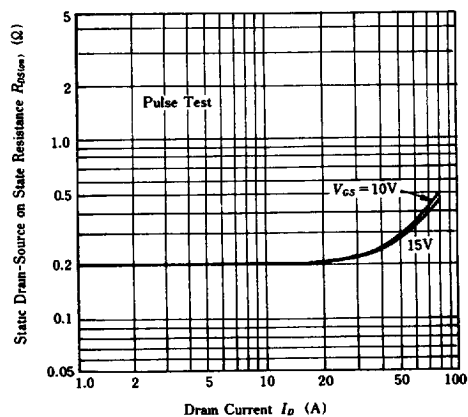
TYPICAL TRANSFER CHARACTERISTICS



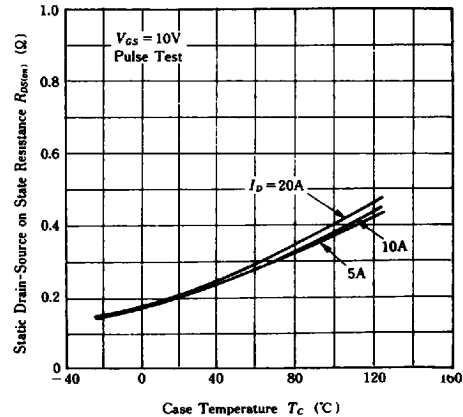
DRAIN-SOURCE SATURATION VOLTAGE VS. GATE-SOURCE VOLTAGE



STATIC DRAIN-SOURCE ON STATE RESISTANCE VS. DRAIN CURRENT

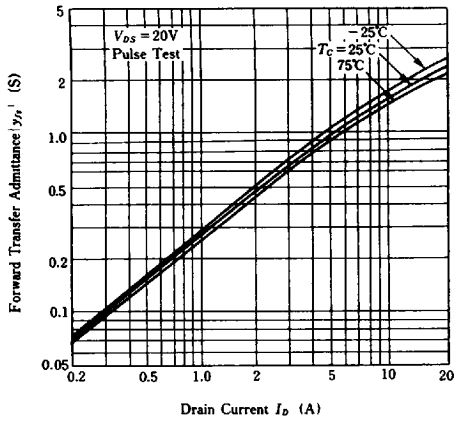


STATIC DRAIN-SOURCE ON STATE RESISTANCE VS. TEMPERATURE

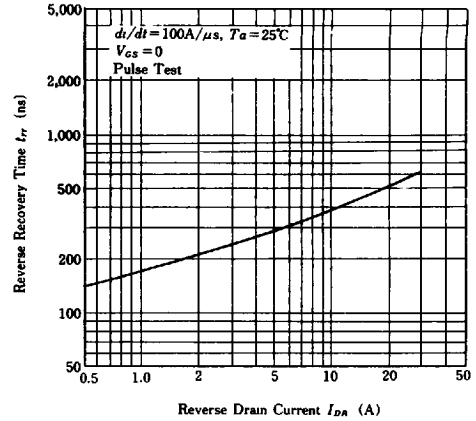


HITACHI/(OPTOELECTRONICS)

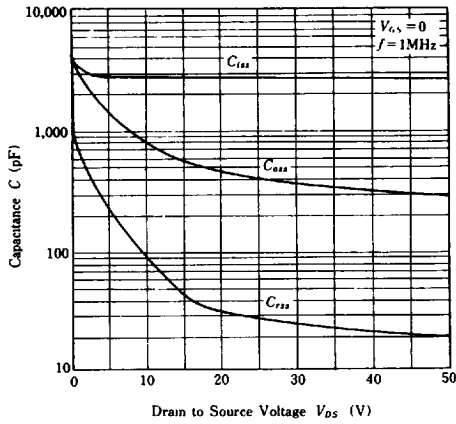
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT



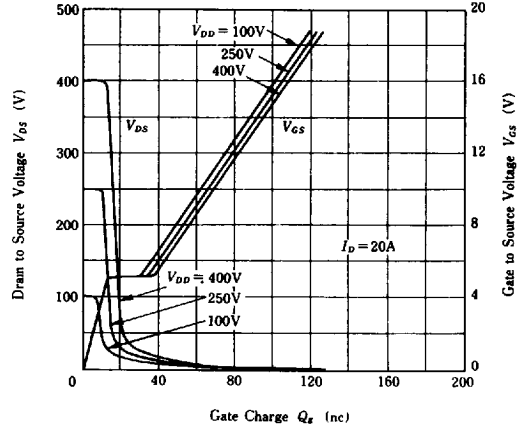
BODY-DRAIN DIODE REVERSE RECOVERY TIME



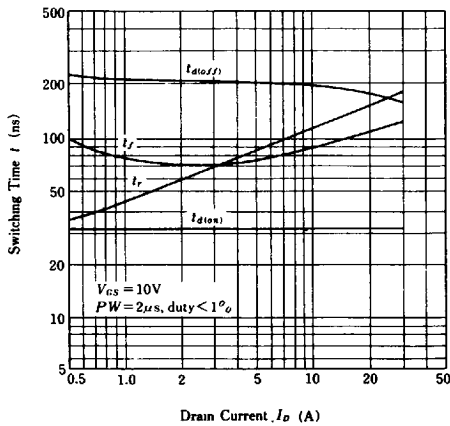
TYPICAL CAPACITANCE VS. DRAIN-SOURCE VOLTAGE



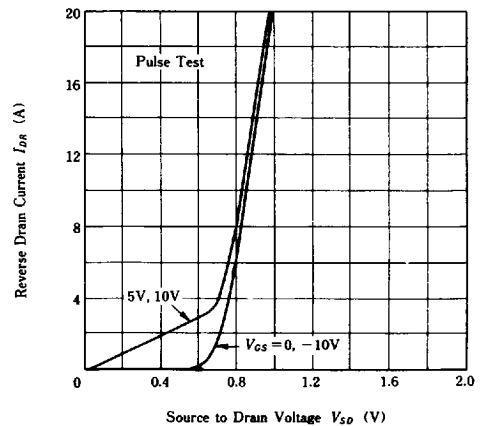
DYNAMIC INPUT CHARACTERISTICS



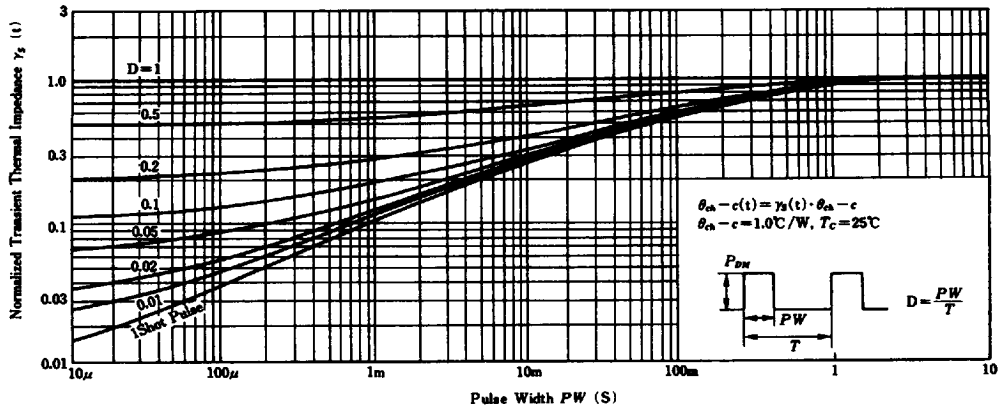
SWITCHING CHARACTERISTICS



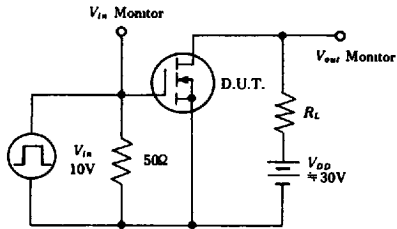
REVERSE DRAIN CURRENT VS. SOURCE TO DRAIN VOLTAGE



NORMALIZED TRANSIENT THERMAL IMPEDANCE VS. PULSE WIDTH



SWITCHING TIME TEST CIRCUIT



WAVEFORMS

